

ESPEC TSD-101-W, TSE-12-A Thermal Shock Chamber



- 2 Zone Elevator System, Air to Air
- superior temperature recovery performance, meet MIL, IEC, JSO and other major environmental test standard
- good temperature uniformity & smooth specimen transfer
- low power consumption

Model	TSE-11-A	TSD-101-W
High temp. exposure range	+60 to +200 °C	+60 to +205 °C
Low temp. exposure range	-65 to 0 °C	-77 to 0 °C
Recovery Condition	High temp. exposure: +150°C, 30min. Low temp. exposure: -65°C, 30min. Specimen: Plastic molded ICs 2kg <i>Air Recovery time: < 5 min.</i>	High temp. exposure: +150°C, 30min. Low temp. exposure: -65°C, 30min. Specimen: Plastic molded ICs 10kg <i>Specimen Recovery time: < 15 min.</i>
Inside Dimension	W320 x H148 x D230mm	W710 x H345 x D410mm
Outside Dimension	W680 x H1745 x D1050 mm	W1100 x H1885 x D1965 mm